

	TECH	INICAL DATA SH	IEET	2/5
EDGE CARD RECEPTACLE				R199.006.413
<b>REEL OF 100</b>				Series : MOEBIUS
PACKAGINGStandardUnit100'W' optionContact us			SPECIFICATION	
ELECTRICAL CHARACTERISTICS			<b>ENVIRONMENTAL</b>	
$\begin{array}{ccccccc} \text{Impedance} & & & & & & \\ \text{Frequency} & & & & & & \\ \text{VSWR} & & & & & & \\ \text{Insertion loss} & & & & & & \\ \text{Voltage rating} & & & & & & \\ \text{Dielectric withstanding voltage} & & & & & & \\ \end{array} \begin{array}{c} \text{50} & \Omega \\ \text{O-6} & \text{GHz} \\ \text{O-6} & \text{GHz} \\ \text{O-7} & \text{O-7} \\ \text{O-7} $		Operating temperature -40/+110 ° C Hermetic seal Atm.cm3/s Panel leakage		
Insulation resistance		MΩ mini	OTHER CHARACTERISTICS	
			Assembly instruc	ction
MECHANIC	CAL CHARACTE	RISTICS	Others :	
Mating life Weight	25000 0,3800	Cycles mini g		
<b>Issue :</b> 0710 A In the effort to improve onecessary.	our products, we reserve	the right to make cha	anges judged to be	RADIALL <sup>®</sup>

#### TECHNICAL DATA SHEET

## **EDGE CARD RECEPTACLE**

## **REEL OF 100**

R199.006.413

Series : MOEBIUS

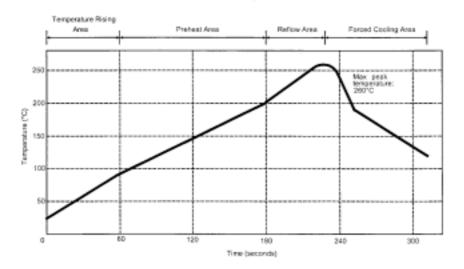
# SOLDER PROCEDURE

 Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux. We advise a thickness of 150 microns mini ( 0.006 inch mini ). Verify that the edges of the zone are clean.

- Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
  Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. Soldering by infra-red reflow. Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

## **TEMPERATURE PROFILE**

INFORMATION ABOUT PAD



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec



